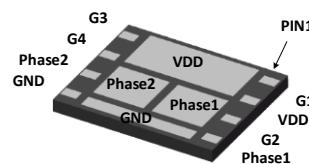
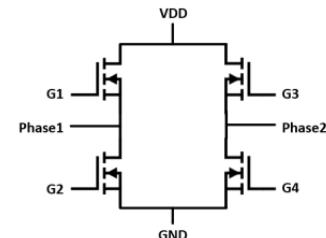


## Main Product Characteristics

$BV_{DSS}$	30V
$R_{DS(ON)}$	10.2mΩ
$I_D$	35A



DFN5x6



Schematic Diagram

## Features and Benefits

- Advanced MOSFET process technology
- Ideal for high efficiency switched mode power supplies
- Low on-resistance with low gate charge
- Fast switching and reverse body recovery



## Description

The GSMP0336 utilizes the latest techniques to achieve high cell density and low on-resistance. These features make this device extremely efficient and reliable for use in high efficiency switch mode power supply and a wide variety of other applications.

## Absolute Maximum Ratings ( $T_C=25^\circ C$ unless otherwise specified)

Parameter	Symbol	Max.	Unit
Drain-Source Voltage	$V_{DS}$	30	V
Gate-Source Voltage	$V_{GS}$	$\pm 20$	V
Drain Current-Continuous ( $T_C=25^\circ C$ )	$I_D$	35	A
Drain Current-Continuous ( $T_C=100^\circ C$ )		22	
Drain Current-Pulsed <sup>1</sup>	$I_{DM}$	140	A
Single Pulse Avalanche Energy <sup>2</sup>	$E_{AS}$	13	mJ
Single Pulse Avalanche Current <sup>2</sup>	$I_{AS}$	16	A
Power Dissipation ( $T_C=25^\circ C$ )	$P_D$	21.5	W
Power Dissipation-Derate above 25°C		0.17	W/°C
Thermal Resistance, Junction-to-Ambient	$R_{\theta JA}$	62	°C/W
Thermal Resistance, Junction-to-Case	$R_{\theta JC}$	5.8	°C/W
Operating Junction Temperature Range	$T_J$	-55 To +150	°C
Storage Temperature Range	$T_{STG}$	-55 To +150	°C

### Electrical Characteristics ( $T_J=25^\circ\text{C}$ unless otherwise specified)

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Unit
<b>On/Off Characteristics</b>						
Drain-Source Breakdown Voltage	$\text{BV}_{\text{DSS}}$	$\text{V}_{\text{GS}}=0\text{V}, \text{I}_D=250\mu\text{A}$	30	-	-	V
$\text{BV}_{\text{DSS}}$ Temperature Coefficient	$\Delta \text{BV}_{\text{DSS}}/\Delta T_J$	Reference to $25^\circ\text{C}$ , $\text{I}_D=1\text{mA}$	-	0.04	-	$\text{V}/^\circ\text{C}$
Drain-Source Leakage Current	$\text{I}_{\text{DSS}}$	$\text{V}_{\text{DS}}=30\text{V}, \text{V}_{\text{GS}}=0\text{V}, T_J=25^\circ\text{C}$	-	-	1	$\mu\text{A}$
		$\text{V}_{\text{DS}}=30\text{V}, \text{V}_{\text{GS}}=0\text{V}, T_J=125^\circ\text{C}$	-	-	10	
Gate-Source Leakage Current	$\text{I}_{\text{GSS}}$	$\text{V}_{\text{GS}}=\pm 20\text{V}, \text{V}_{\text{DS}}=0\text{V}$	-	-	$\pm 100$	nA
Static Drain-Source On-Resistance <sup>3</sup>	$\text{R}_{\text{DS}(\text{ON})}$	$\text{V}_{\text{GS}}=10\text{V}, \text{I}_D=10\text{A}$	-	8.4	10.2	$\text{m}\Omega$
		$\text{V}_{\text{GS}}=4.5\text{V}, \text{I}_D=5\text{A}$	-	11.6	15	
Gate Threshold Voltage	$\text{V}_{\text{GS}(\text{th})}$	$\text{V}_{\text{GS}}=\text{V}_{\text{DS}}, \text{I}_D=250\mu\text{A}$	1.2	1.8	2.5	V
$\text{V}_{\text{GS}(\text{th})}$ Temperature Coefficient	$\Delta \text{V}_{\text{GS}(\text{th})}$		-	-4	-	$\text{mV}/^\circ\text{C}$
Forward Transconductance	$\text{g}_{\text{fs}}$	$\text{V}_{\text{DS}}=10\text{V}, \text{I}_D=3\text{A}$	-	6.4	-	S
<b>Dynamic and Switching Characteristics</b>						
Total Gate Charge <sup>3,4</sup>	$\text{Q}_g$	$\text{V}_{\text{DS}}=15\text{V}, \text{I}_D=5\text{A}, \text{V}_{\text{GS}}=10\text{V}$	-	16.5	33	nC
Gate-Source Charge <sup>3,4</sup>	$\text{Q}_{\text{gs}}$		-	2.3	5.0	
Gate-Drain Charge <sup>3,4</sup>	$\text{Q}_{\text{gd}}$		-	3.0	6.0	
Turn-On Delay Time <sup>3,4</sup>	$t_{\text{d}(\text{on})}$	$\text{V}_{\text{DD}}=15\text{V}, \text{R}_G=6\Omega, \text{V}_{\text{GS}}=10\text{V}, \text{I}_D=1\text{A}$	-	3.8	7.0	nS
Rise Time <sup>3,4</sup>	$\text{t}_r$		-	10.0	19	
Turn-Off Delay Time <sup>3,4</sup>	$t_{\text{d}(\text{off})}$		-	22.0	42	
Fall Time <sup>3,4</sup>	$\text{t}_f$		-	6.6	13	
Input Capacitance	$\text{C}_{\text{iss}}$	$\text{V}_{\text{DS}}=25\text{V}, \text{V}_{\text{GS}}=0\text{V}, \text{F}=1\text{MHz}$	-	620	900	pF
Output Capacitance	$\text{C}_{\text{oss}}$		-	85	125	
Reverse Transfer Capacitance	$\text{C}_{\text{rss}}$		-	60	90	
Gate Resistance	$\text{R}_g$	$\text{V}_{\text{GS}}=0\text{V}, \text{V}_{\text{DS}}=0\text{V}, \text{F}=1\text{MHz}$	-	2.8	5.6	$\Omega$
<b>Drain-Source Diode Characteristics and Maximum Ratings</b>						
Continuous Source Current	$\text{I}_s$	$\text{V}_G=\text{V}_D=0\text{V}$ , Force Current	-	-	35	A
Pulsed Source Current <sup>3</sup>	$\text{I}_{\text{SM}}$		-	-	70	A
Diode Forward Voltage <sup>3</sup>	$\text{V}_{\text{SD}}$	$\text{V}_{\text{GS}}=0\text{V}, \text{I}_s=1\text{A}, T_J=25^\circ\text{C}$	-	-	1	V

Note:

- Repetitive rating: Pulsed width limited by maximum junction temperature.
- $\text{V}_{\text{DD}}=25\text{V}, \text{V}_{\text{GS}}=10\text{V}, \text{L}=0.1\text{mH}, \text{I}_{\text{AS}}=16\text{A}, \text{R}_G=25\Omega$ , starting  $T_J=25^\circ\text{C}$ .
- Pulse test: pulse width  $\leq 300\text{us}$ , duty cycle  $\leq 2\%$ .
- Essentially independent of operation temperature.

## Typical Electrical and Thermal Characteristic Curves

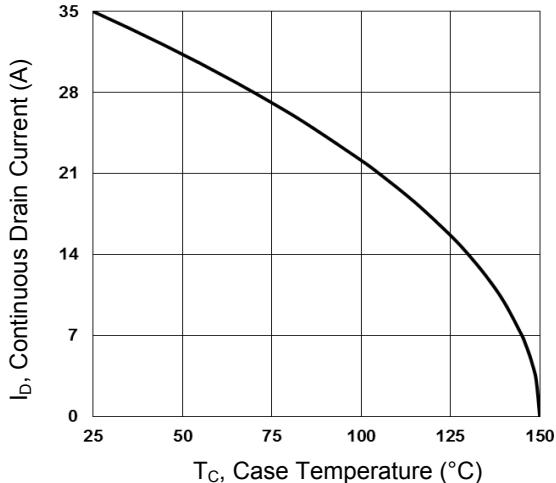


Figure 1. Continuous Drain Current vs. T<sub>c</sub>

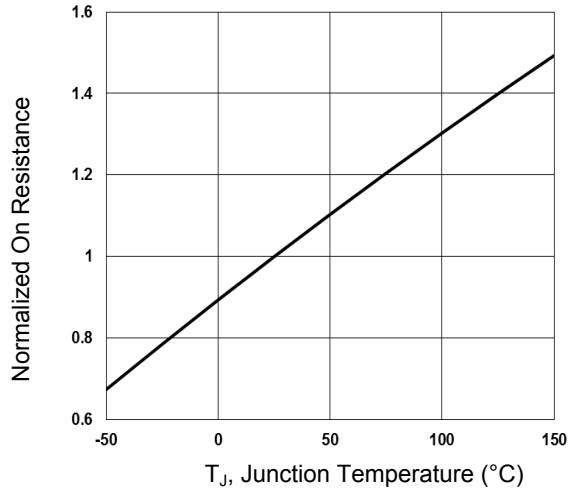


Figure 2. Normalized R<sub>DS(ON)</sub> vs. T<sub>j</sub>

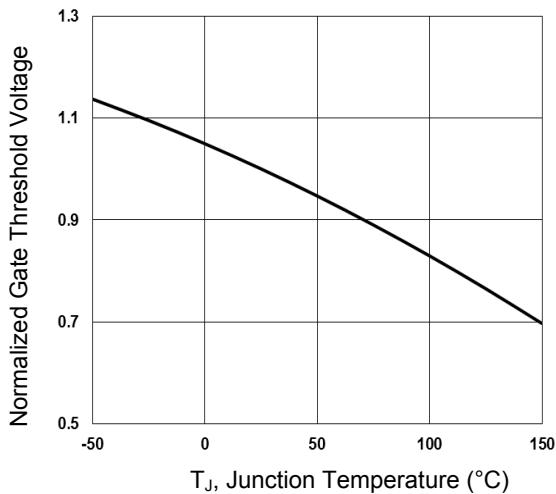


Figure 3. Normalized V<sub>th</sub> vs. T<sub>j</sub>

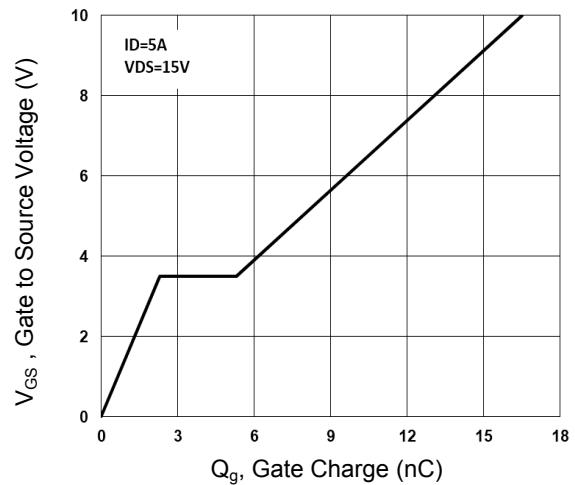


Figure 4. Gate Charge Characteristics

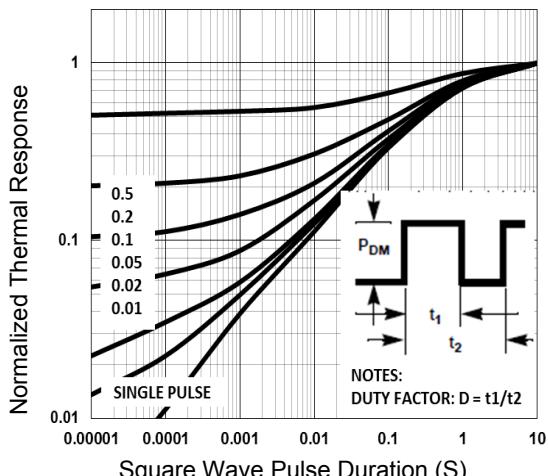


Figure 5. Normalized Transient Response

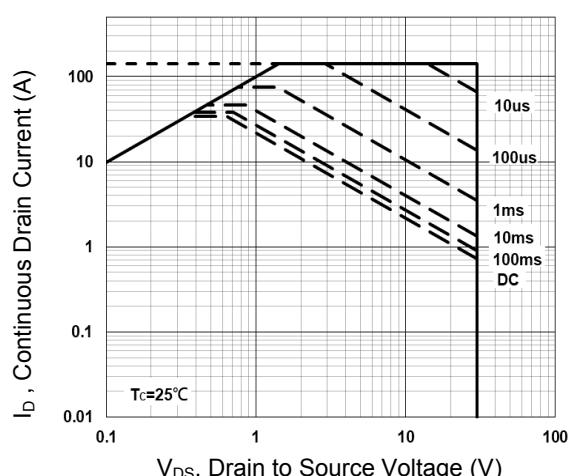


Figure 6. Maximum Safe Operation Area

### Typical Electrical and Thermal Characteristic Curves

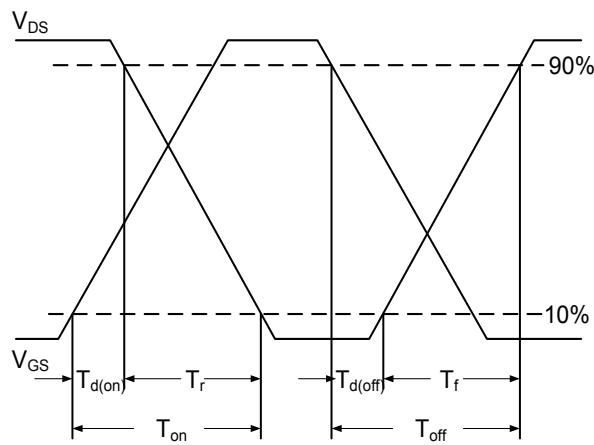


Figure 7. Switching Time Waveform

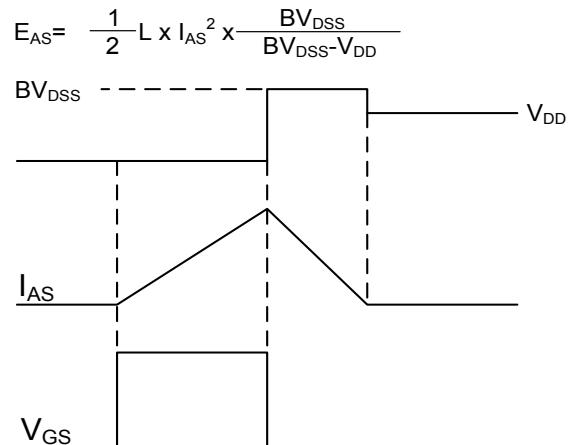
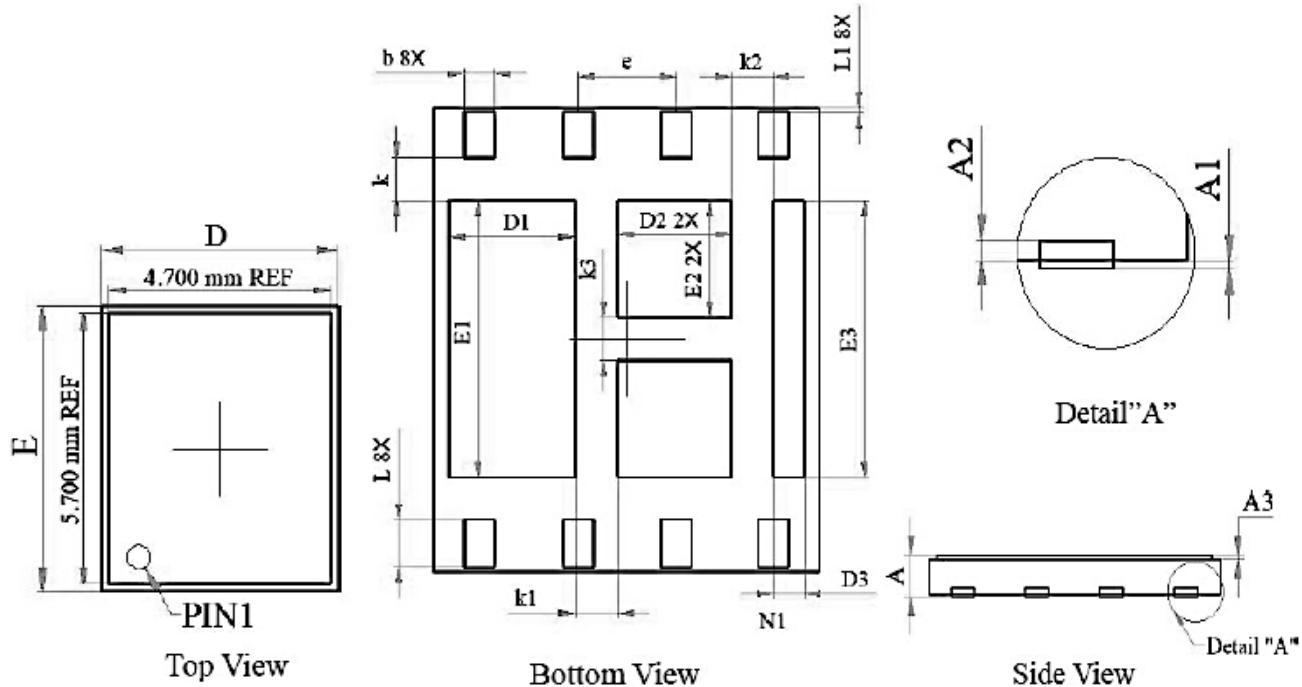


Figure 8. Gate Charge Waveform

### Package Outline Dimensions

**DFN5x6**



Symbol	Dimensions In Millimeters			Symbol	Dimensions In Millimeters		
	MIN	Normal	MAX		MIN	Normal	MAX
A	0.530	-	0.600	D3	0.300	0.400	0.500
A1	-	-	0.005	E3	3.500	3.600	3.700
A2	0.030	-	0.100	b	0.350	0.400	0.450
A3	0.050	-	0.100	L	0.550	0.600	0.650
D	4.900	5.000	5.100	L1	0.010	0.050	0.090
E	5.900	6.000	6.100	k	0.550 REF		
D1	1.525	1.625	1.725	k1	0.550 REF		
E1	3.500	3.600	3.700	k2	0.550 REF		
D2	1.375	1.475	1.575	k3	0.550 REF		
E2	1.425	1.525	1.625	e	1.27 BSC		

## Recommended Pad Layout

